Lighting ColorYellow Green

LN316GPH

Square Type

 \Box 3.0 mm \times 7.0 mm

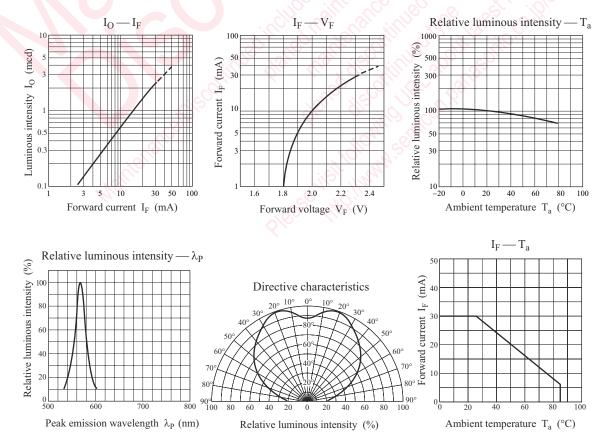
Absolute Maximum Ratings $T_a = 25^{\circ}C$

| Parameter | Symbol | Rating | Unit |
|-------------------------------|------------------|-------------|------|
| Power dissipation | P _D | 90 | mW |
| Forward current | I _F | 30 | mA |
| Pulse forward current * | I _{FP} | 150 | mA |
| Reverse voltage | V _R | 4 | V |
| Operating ambient temperature | T _{opr} | -25 to +85 | °C |
| Storage temperature | T _{stg} | -30 to +100 | °C |

Note) *: The condition of IFP is duty 10%, Pulse width 1 msec.

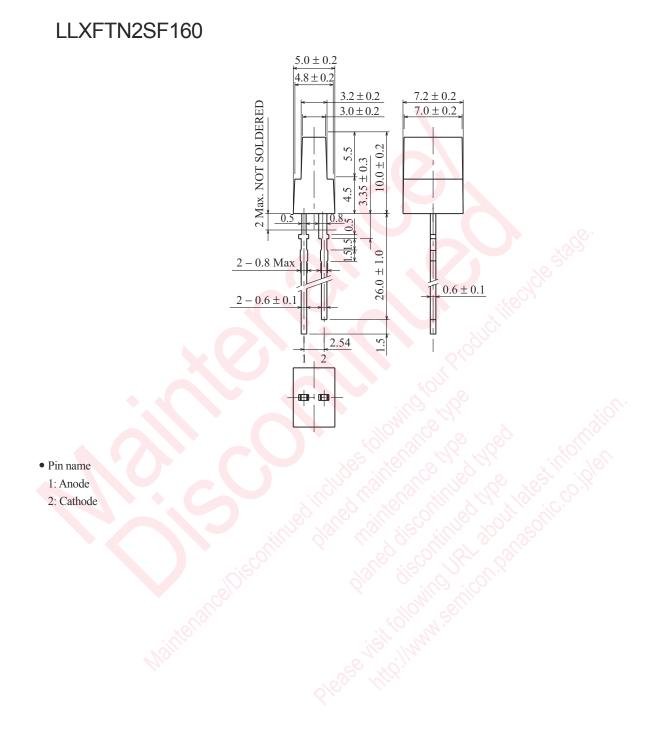
Electro-Optical Characteristics $T_a = 25^{\circ}C$

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--------------------------|-------------------|-----------------------|-----|------|-----|------|
| Luminous intensity | Io | | 0.6 | 1.5 | | mcd |
| Reverse current | I _R | $V_R = 4 V$ | | | 10 | μΑ |
| Forward voltage | V _F | $I_F = 20 \text{ mA}$ | | 2.2 | 2.8 | V |
| Peak emission wavelength | $\lambda_{\rm P}$ | $I_F = 20 \text{ mA}$ | 00 | 565 | CO. | nm |
| Spectral half band width | Δλ | $I_F = 20 \text{ mA}$ | 5 | . 30 | 101 | nm |



LN316GPH

Package (Unit: mm)



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